## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

SOTOME, Yoshihiro

Serial No. 10/038,680

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Confirmation No. 8985

Allowed: February 18, 2004

Atty. Ref.: 900-410

Group: 2825

Group. 2023

Filed: January 8, 2002

Examiner: Lee, Calvin

For: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE AND THE

SEMICONDUCTOR DEVICE MANUFACTURED BY THE METHOD

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May 7, 2004

Mail Stop: Issue Fee

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## **COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE**

The instant application was allowed February 18, 2004. However, the Reasons for Allowance are <u>not</u> commensurate with the scope of the claims.

For example, and without limitation, claim 13 does not require thermal treating for forming a second silicide film "on a substrate's surface" as recited in the reasons for allowance.

Please let me know if you should have any questions.

Respectfully submitted,

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